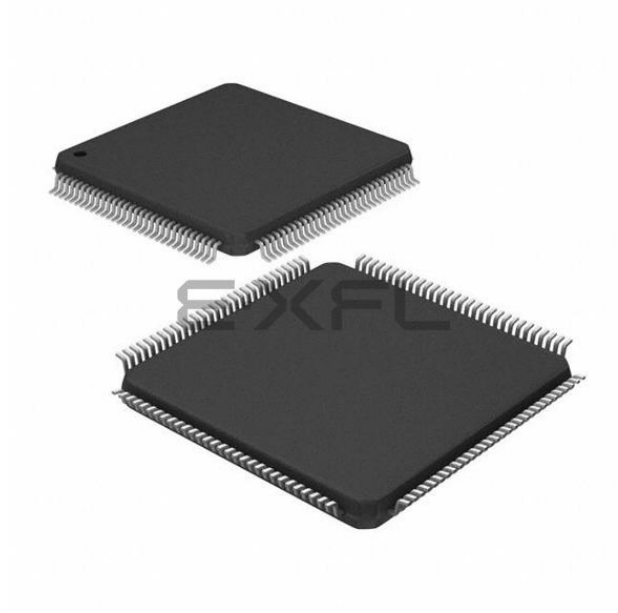
Infineon Technologies - MB90922NCSPMC-GS-142E1 Datasheet



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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	32MHz
Connectivity	CANbus, LINbus, UART/USART
Peripherals	LCD, LVD, POR, PWM, WDT
Number of I/O	93
Program Memory Size	256KB (256K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	120-LQFP
Supplier Device Package	120-LQFP (16x16)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90922ncspmc-gs-142e1

Pin no.	Pin name	I/O circuit type*1	Function
104	P13	I	General-purpose I/O port
	PPG5		16-bit PPG ch.5 output pin
109	P14	I	General-purpose I/O port
	TIN2		16-bit reload timer ch.2 TIN input pin
	IN1		Input capture ch.1 trigger input pin
110	P15	I	General-purpose I/O port
	IN0		Input capture ch.0 trigger input pin
111	COM0	P	LCD controller/driver common output pin
112	COM1	P	LCD controller/driver common output pin
113	COM2	P	LCD controller/driver common output pin
114	COM3	P	LCD controller/driver common output pin
115	P22	F	General-purpose I/O port
	SEG00		LCD controller/driver segment output pin
116	P23	F	General-purpose I/O port
	SEG01		LCD controller/driver segment output pin
117	P24	F	General-purpose I/O port
	SEG02		LCD controller/driver segment output pin
118	P25	F	General-purpose I/O port
	SEG03		LCD controller/driver segment output pin
119	P26	F	General-purpose I/O port
	SEG04		LCD controller/driver segment output pin
120	P27	F	General-purpose I/O port
	SEG05		LCD controller/driver segment output pin
1	P30	F	General-purpose I/O port
	SEG06		LCD controller/driver segment output pin
2	P31	F	General-purpose I/O port
	SEG07		LCD controller/driver segment output pin
3	P32	F	General-purpose I/O port
	SEG08		LCD controller/driver segment output pin
4	P33	F	General-purpose I/O port
	SEG09		LCD controller/driver segment output pin
5	P34	F	General-purpose I/O port
	SEG10		LCD controller/driver segment output pin
6	P35	F	General-purpose I/O port
	SEG11		LCD controller/driver segment output pin

(Continued)

Pin no.	Pin name	I/O circuit type*1	Function
61	P54	I	General-purpose I/O port
	TX0		CAN interface 0 TX output pin
	TX2		CAN interface 2 TX output pin
	SGA1		Sound generator ch.1 SGA output pin
63	P55	I	General-purpose I/O port
	RX0		CAN interface 0 RX input pin
	RX2		CAN interface 2 RX input pin
	INT2		INT2 external interrupt input pin
91	P56	I	General-purpose I/O port
	SGO0		Sound generator ch.0 SGO output pin
	FRCK		Free-run timer clock input pin
92	P57	I	General-purpose I/O port
	SGA0		Sound generator ch.0 SGA output pin
39	P60	H	General-purpose I/O port
	AN0		A/D converter input pin
40	P61	H	General-purpose I/O port
	AN1		A/D converter input pin
41	P62	H	General-purpose I/O port
	AN2		A/D converter input pin
42	P63	H	General-purpose I/O port
	AN3		A/D converter input pin
43	P64	H	General-purpose I/O port
	AN4		A/D converter input pin
44	P65	H	General-purpose I/O port
	AN5		A/D converter input pin
45	P66	H	General-purpose I/O port
	AN6		A/D converter input pin
46	P67	H	General-purpose I/O port
	AN7		A/D converter input pin
67	P70	L	General-purpose output-only port
	PWM1P0		Stepping motor controller ch.0 output pin
68	P71	L	General-purpose output-only port
	PWM1M0		Stepping motor controller ch.0 output pin
69	P72	L	General-purpose output-only port
	PWM2P0		Stepping motor controller ch.0 output pin

(Continued)

Pin no.	Pin name	I/O circuit type*1	Function
70	P73	L	General-purpose output-only port
	PWM2M0		Stepping motor controller ch.0 output pin
71	P74	L	General-purpose output-only port
	PWM1P1		Stepping motor controller ch.1 output pin
72	P75	L	General-purpose output-only port
	PWM1M1		Stepping motor controller ch.1 output pin
73	P76	L	General-purpose output-only port
	PWM2P1		Stepping motor controller ch.1 output pin
74	P77	L	General-purpose output-only port
	PWM2M1		Stepping motor controller ch.1 output pin
77	P80	L	General-purpose output-only port
	PWM1P2		Stepping motor controller ch.2 output pin
78	P81	L	General-purpose output-only port
	PWM1M2		Stepping motor controller ch.2 output pin
79	P82	L	General-purpose output-only port
	PWM2P2		Stepping motor controller ch.2 output pin
80	P83	L	General-purpose output-only port
	PWM2M2		Stepping motor controller ch.2 output pin
81	P84	L	General-purpose output-only port
	PWM1P3		Stepping motor controller ch.3 output pin
82	P85	L	General-purpose output-only port
	PWM1M3		Stepping motor controller ch.3 output pin
83	P86	L	General-purpose output-only port
	PWM2P3		Stepping motor controller ch.3 output pin
84	P87	L	General-purpose output-only port
	PWM2M3		Stepping motor controller ch.3 output pin
22	P90	F	General-purpose I/O port
	SEG22		LCD controller/driver segment output pin
23	P91	F	General-purpose I/O port
	SEG23		LCD controller/driver segment output pin
31	P94	G	General-purpose I/O port
	V0		LCD controller/driver reference power supply pin
32	P95	G	General-purpose I/O port
	V1		LCD controller/driver reference power supply pin

(Continued)

■ HANDLING DEVICES

• Strictly observe maximum rated voltages (preventing latch-up)

In CMOS IC devices, a condition known as latch-up may occur if voltages higher than V_{CC} or lower than V_{SS} are applied to input or output pins other than medium or high withstand voltage pins, or if the voltage applied between VCC and VSS pins exceeds the rated voltage level. If a latch-up occurs, the power supply current may increase dramatically and may destroy semiconductor elements. When using semiconductor devices, always take sufficient care to avoid exceeding maximum ratings.

When the analog system power supply is switched on or off, be careful not to apply the analog power supply (AV_{CC}, AVRH), the analog input voltages and the power supply voltage for the high current output buffer pins (DV_{CC}) in excess of the digital power supply voltage (V_{CC}).

Once the digital power supply voltage (V_{CC}) has been disconnected, the analog power supply (AV_{CC}, AVRH) and the power supply voltage for the high current output buffer pins (DV_{CC}) may be turned on in any sequence.

• Supply voltage stabilization

Rapid fluctuations in the power supply voltage can cause malfunctions even if the Vcc power supply voltage remains within the warranted operating range. It is recommended that the power supply be stabilized such that ripple fluctuations (P-P value) at commercial frequencies (50 Hz/60 Hz) be limited to within 10% of the standard V_{CC} value, and that transient fluctuations due to power supply switching, etc. be limited to a rate of 0.1 V/ms or less.

• Precautions when turning the power on

In order to prevent the built-in step-down circuits from malfunctioning, the time taken for the voltage to rise (0.2 V to 2.7 V) during power-on should be less than 50 μs.

• Handling unused pins

If unused input pins are left open, they may cause malfunctions or latch-up which may lead to permanent damage to the semiconductor. Unused input pins should therefore be pulled up or pulled down through a resistor of at least 2 kΩ.

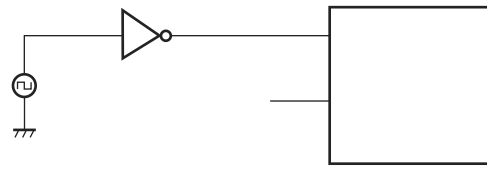
Unused input/output pins may be set to the output state and left open, or set to the input state and connected to a pull-up or pull-down resistance of 2 kΩ or more.

• Handling A/D converter power supply pins

Even if the A/D converter is not used, the power supply pins should be connected such as $AV_{CC} = V_{CC}$, and $AV_{SS} = AVRH = V_{SS}$.

• Notes on using an external clock

Even when an external clock is used, an oscillation stabilization wait time is required following power-on reset or release from sub clock mode or stop mode. Furthermore, only the X0A pin should be driven when an external clock is used, with the X1A pin open as shown in the following diagram. Do not use high-speed oscillation pins (X0 and X1) for external clock input.



Sample external clock connection

- **Notes on operating in PLL clock mode**

On this microcontroller, if in case the crystal oscillator breaks off or an external reference clock input stops while the PLL clock mode is selected, a self-oscillator circuit contained in the PLL may continue its operation at its self-running frequency. However, FUJITSU SEMICONDUCTOR will not guarantee results of operations if such failure occurs.

- **Crystal oscillator circuit**

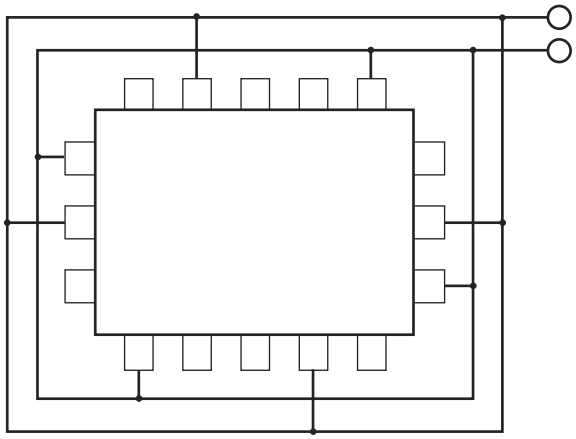
Noise around the X0/X1, or X0A/X1A pins may cause this device to operate abnormally. In the interest of stable operation it is strongly recommended that printed circuit artwork places ground bypass capacitors as close as possible to the X0/X1, X0A/X1A and crystal oscillator (or ceramic oscillator) and that oscillator lines do not cross the lines of other circuits.

Please ask each crystal maker to evaluate the oscillational characteristics of the crystal and this device.

- **Power supply pins**

Devices including multiple VCC or VSS pins are designed such that pins that need to be at the same potential are interconnected internally to prevent malfunctions such as latch-up. To reduce unnecessary radiation, prevent malfunctioning of the strobe signal due to the rise of ground level, and observe the standard for total output current, be sure to connect the VCC and VSS pins to the power supply and ground externally.

Always connect all of the VCC pins to the same potential and all of the VSS pins to ground as shown in the following diagram. The device will not operate correctly if multiple VCC or VSS pins are connected to different voltages, even if those voltages are within the guaranteed operating ranges.



Power supply input pins (Vcc/Vss)

In addition, care must be given to connecting the VCC and VSS pins of this device to the current supply source with as low impedance as possible. It is recommended that a 1.0 μF bypass capacitor be connected between the VCC and VSS pins as close to the pins as possible.

- **Sequence for connecting the A/D converter power supply and analog inputs**

The A/D converter power supply (AV_{CC}, AVRH) and analog inputs (AN0 to AN7) must be applied after the digital power supply (V_{CC}) is switched on. When turning the power off, the A/D converter power supply and analog inputs must be disconnected before the digital power supply is switched off (V_{CC}). Ensure that AVRH does not exceed AVcc during either power-on or power-off. Even when pins which double as analog input pins are used as input ports, be sure that the input voltage does not exceed AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable).

- **Handling the power supply for high-current output buffer pins** (DV_{CC}, DV_{SS})

  - **Flash memory products and MASK ROM products (MB90F922NC/F922NCS/922NCS/F923NC/ F923NCS/F924NC/F924NCS)**

    In the Flash memory products and MASK ROM products, the power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) is isolated from the digital power supply (V_{CC}).
    Therefore, DVcc can therefore be set to a higher voltage than Vcc. If the power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) is supplied before the digital power supply (V_{CC}), however, care needs to be taken because it is possible that the port 7 or port 8 stepping motor outputs may momentarily output an “H” or “L” level. In order to prevent this, connect the digital power supply (V_{CC}) prior to connecting the power supply for the high-current output buffer pins. Even when the high-current output buffer pins are used as general-purpose ports, power should be supplied to the power supply pins for the high-current output buffer pins (DV_{CC}, DV_{SS}).

  - **Evaluation product** (**MB90V920-101**/**MB90V920-102**)

    In the evaluation products, the power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) is not isolated from the digital power supply (V_{CC}). Therefore, DV_{CC} must therefore be set to a lower voltage than Vcc. The power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) must always be applied after the digital power supply (V_{CC}) has been connected, and disconnected before the digital power supply (Vcc) is disconnected (the power supply for the high-current output buffer pins may also be connected and disconnected simultaneously with the digital power supply).
    Even when the high-current output buffer pins are used as general-purpose ports, power should be supplied to the power supply pins for the high-current output buffer pins (DV_{CC}, DV_{SS}).

- **Pull-up/pull-down resistors**

MB90920 series does not support internal pull-up/pull-down resistors. Use external components as necessary.

- **Precautions when not using a sub clock signal**

If the X0A and X1A pins are not connected to an oscillator, apply a pull-down resistance to the X0A pin and leave the X1A pin open.

- **Notes on operating when the external clock is stopped**

The MB90920 series is not guaranteed to operate correctly using the internal oscillator circuit when there is no external oscillator or the external clock input is stopped.

- **Flash memory security function**

A security bit is located within the Flash memory region. The security function is activated by writing the protection code 01_H to the security bit.
Do not write the value 01_H to this address if you are not using the security function.
Please refer to following table for the address of the security bit.

	Flash memory size	Address for security bit
MB90F922NC MB90F922NCS	Built-in 2 Mbits Flash Memory	$FC0001_H$
MB90F923NCS	Built-in 3 Mbits Flash Memory	$F80001_H$
MB90F924NCS	Built-in 4 Mbits Flash Memory	$F80001_H$

- **Serial communication**

In serial communication, reception of wrong data may occur due to noise or other causes. Therefore, design a printed circuit board to prevent noise from occurring. Taking account of the reception of wrong data, detect errors by measures such as adding a checksum to the end of data. If an error is detected, retransmit the data.

- **Characteristic difference between flash device and MASK ROM device**

In the flash device and the MASK ROM device, the electrical characteristic including current consumption, ESD, latch-up, the noise characteristic, and oscillation characteristic, etc. is different according to the difference between the chip layout and the memory structure.

Reconfirm the electrical characteristic when the product is replaced by another product of the same series.

■ I/O MAP

Address	Register name	Symbol	Read/write	Resource name	Initial value
000000H	Port 0 data register	PDR0	R/W	Port 0	XXXXXXXXB
000001H	Port 1 data register	PDR1	R/W	Port 1	XXXXXXXXB
000002H	Port 2 data register	PDR2	R/W	Port 2	XXXXXXXXB
000003H	Port 3 data register	PDR3	R/W	Port 3	XXXXXXXXB
000004H	Port 4 data register	PDR4	R/W	Port 4	XXXXXXXXB
000005H	Port 5 data register	PDR5	R/W	Port 5	XXXXXXXXB
000006H	Port 6 data register	PDR6	R/W	Port 6	XXXXXXXXB
000007H	Port 7 data register	PDR7	R/W	Port 7	XXXXXXXXB
000008H	Port 8 data register	PDR8	R/W	Port 8	XXXXXXXXB
000009H	Port 9 data register	PDR9	R/W	Port 9	XXXXXXXXB
00000AH, 00000BH	(Disabled)				
00000CH	Port C data register	PDRC	R/W	Port C	XXXXXXXXB
00000DH	Port D data register	PDRD	R/W	Port D	XXXXXXXXB
00000EH	Port E data register	PDRE	R/W	Port E	XXXXXXXXB
00000FH	(Disabled)				
000010H	Port 0 direction register	DDR0	R/W	Port 0	00000000B
000011H	Port 1 direction register	DDR1	R/W	Port 1	XX000000B
000012H	Port 2 direction register	DDR2	R/W	Port 2	000000XXB
000013H	Port 3 direction register	DDR3	R/W	Port 3	00000000B
000014H	Port 4 direction register	DDR4	R/W	Port 4	00000000B
000015H	Port 5 direction register	DDR5	R/W	Port 5	00000000B
000016H	Port 6 direction register	DDR6	R/W	Port 6	00000000B
000017H	Port 7 direction register	DDR7	R/W	Port 7	00000000B
000018H	Port 8 direction register	DDR8	R/W	Port 8	00000000B
000019H	Port 9 direction register	DDR9	R/W	Port 9	X0000000B
00001AH	Analog input enable	ADER6	R/W	Port 6, A/D	11111111B
00001BH	(Disabled)				
00001CH	Port C direction register	DDRC	R/W	Port C	00000000B
00001DH	Port D direction register	DDRD	R/W	Port D	X0000000B
00001EH	Port E direction register	DDRE	R/W	Port E	XXXXX000B
00001FH	(Disabled)				
000020H	Lower A/D control status register	ADCS0	R/W	A/D converter	000XXXX0B
000021H	Higher A/D control status register	ADCS1	R/W		0000000XB
000022H	Lower A/D control status register	ADCR0	R		00000000B
000023H	Higher A/D data register	ADCR1	R		XXXXXX00B

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Address	Register name	Symbol	Read/write	Resource name	Initial value
0000D4H	Lower timer control status register 2	TMCSR2L	R/W	16-bit reload timer 2	00000000B
0000D5H	Higher timer control status register 2	TMCSR2H	R/W		XXX10000B
0000D6H	Lower timer control status register 3	TMCSR3L	R/W	16-bit reload timer 3	00000000B
0000D7H	Higher timer control status register 3	TMCSR3H	R/W		XXX10000B
0000D8H	Lower sound control register 1	SGCRL1	R/W	Sound generator 1	00000000B
0000D9H	Higher sound control register 1	SGCRH1	R/W		0XXXX100B
0000DAH	Lower PPG3 control status register	PCNTL3	R/W	16-bit PPG3	00000000B
0000DBH	Higher PPG3 control status register	PCNTH3	R/W		00000001B
0000DCH	Lower PPG4 control status register	PCNTL4	R/W	16-bit PPG4	00000000B
0000DDH	Higher PPG4 control status register	PCNTH4	R/W		00000001B
0000DEH	Lower PPG5 control status register	PCNTL5	R/W	16-bit PPG5	00000000B
0000DFH	Higher PPG5 control status register	PCNTH5	R/W		00000001B
0000E0H	Serial mode register 2	SMR2	R/W, W	UART (LIN/SCI) 2	00000000B
0000E1H	Serial control register 2	SCR2	R/W, W		00000000B
0000E2H	Reception/transmission data register 2	RDR2/ TDR2	R/W		00000000B
0000E3H	Serial status register 2	SSR2	R/W, R		00001000B
0000E4H	Extended communication control register 2	ECCR2	R/W, R		000000XXB
0000E5H	Extended status control register 2	ESCR2	R/W		00000100B
0000E6H	Baud rate generator register 20	BGR20	R/W		00000000B
0000E7H	Baud rate generator register 21	BGR21	R/W, R		00000000B
0000E8H	Serial mode register 3	SMR3	R/W, W	UART (LIN/SCI) 3	00000000B
0000E9H	Serial control register 3	SCR3	R/W, W		00000000B
0000EAH	Reception/transmission data register 3	RDR3/ TDR3	R/W		00000000B
0000EBH	Serial status register 3	SSR3	R/W, R		00001000B
0000ECH	Extended communication control register 3	ECCR3	R/W, R		000000XXB
0000EDH	Extended status control register 3	ESCR3	R/W		00000100B
0000EEH	Baud rate generator register 30	BGR30	R/W		00000000B
0000EFH	Baud rate generator register 31	BGR31	R/W, R		00000000B
001FF0H	Program address detection register 0	PADR0	R/W	Address match detection	XXXXXXXXB
001FF1H	Program address detection register 1	PADR0	R/W		XXXXXXXXB
001FF2H	Program address detection register 2	PADR0	R/W		XXXXXXXXB
001FF3H	Program address detection register 3	PADR1	R/W		XXXXXXXXB
001FF4H	Program address detection register 4	PADR1	R/W		XXXXXXXXB
001FF5H	Program address detection register 5	PADR1	R/W		XXXXXXXXB

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
003970H to 003973H	(Disabled)				
003974H	Frequency data register 1	SGFR1	R/W	Sound generator 1	XXXXXXXXB
003975H	Amplitude data register 1	SGAR1	R/W		00000000B
003976H	Decrement grade register 1	SGDR1	R/W		XXXXXXXXB
003977H	Tone count register 1	SGTR1	R/W		XXXXXXXXB
003978H to 00397FH	(Disabled)				
003980H	PWM1 compare register 0	PWC10	R/W	Stepping motor controller 0	XXXXXXXXB
003981H					XXXXXXXXB
003982H	PWM2 compare register 0	PWC20	R/W		XXXXXXXXB
003983H					XXXXXXXXB
003984H	PWM1 select register 0	PWS10	R/W		00000000B
003985H	PWM2 select register 0	PWS20	R/W		X0000000B
003986H, 003987H	(Disabled)				
003988H	PWM1 compare register 1	PWC11	R/W	Stepping motor controller 1	XXXXXXXXB
003989H					XXXXXXXXB
00398AH	PWM2 compare register 1	PWC21	R/W		XXXXXXXXB
00398BH					XXXXXXXXB
00398CH	PWM1 select register 1	PWS11	R/W		00000000B
00398DH	PWM2 select register 1	PWS21	R/W		X0000000B
00398EH, 00398FH	(Disabled)				
003990H	PWM1 compare register 2	PWC12	R/W	Stepping motor controller 2	XXXXXXXXB
003991H					XXXXXXXXB
003992H	PWM2 compare register 2	PWC22	R/W		XXXXXXXXB
003993H					XXXXXXXXB
003994H	PWM1 select register 2	PWS12	R/W		00000000B
003995H	PWM2 select register 2	PWS22	R/W		X0000000B
003996H, 003997H	(Disabled)				

(Continued)

List of Control Registers(2)

Address				Register	Abbre-viation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
000040H	000070H	0039C0H	0039D0H	Message buffer valid register	BVALR	R/W	00000000B
000041H	000071H	0039C1H	0039D1H				00000000B
000042H	000072H	0039C2H	0039D2H	Transmit request register	TREQR	R/W	00000000B
000043H	000073H	0039C3H	0039D3H				00000000B
000044H	000074H	0039C4H	0039D4H	Transmit cancel register	TCANR	W	00000000B
000045H	000075H	0039C5H	0039D5H				00000000B
000046H	000076H	0039C6H	0039D6H	Transmit complete register	TCR	R/W	00000000B
000047H	000077H	0039C7H	0039D7H				00000000B
000048H	000078H	0039C8H	0039D8H	Receive complete register	RCR	R/W	00000000B
000049H	000079H	0039C9H	0039D9H				00000000B
00004AH	00007AH	0039CAH	0039DAH	Remote request receive register	RRTRR	R/W	00000000B
00004BH	00007BH	0039CBH	0039DBH				00000000B
00004CH	00007CH	0039CCH	0039DCH	Receive overrun register	ROVRR	R/W	00000000B
00004DH	00007DH	0039CDH	0039DDH				00000000B
00004EH	00007EH	0039CEH	0039DEH	Receive interrupt enable register	RIER	R/W	00000000B
00004FH	00007FH	0039CFH	0039DFH				00000000B
003C08H	003D08H	003E08H	003F08H	IDE register	IDER	R/W	XXXXXXXXB
003C09H	003D09H	003E09H	003F09H				XXXXXXXXB
003C0AH	003D0AH	003E0AH	003F0AH	Transmit RTR register	TRTRR	R/W	00000000B
003C0BH	003D0BH	003E0BH	003F0BH				00000000B
003C0CH	003D0CH	003E0CH	003F0CH	Remote frame receive wait register	RFWTR	R/W	XXXXXXXXB
003C0DH	003D0DH	003E0DH	003F0DH				XXXXXXXXB
003C0EH	003D0EH	003E0EH	003F0EH	Transmit interrupt enable register	TIER	R/W	00000000B
003C0FH	003D0FH	003E0FH	003F0FH				00000000B
003C10H	003D10H	003E10H	003F10H	Acceptance mask select register	AMSR	R/W	XXXXXXXXB
003C11H	003D11H	003E11H	003F11H				XXXXXXXXB
003C12H	003D12H	003E12H	003F12H				XXXXXXXXB
003C13H	003D13H	003E13H	003F13H				XXXXXXXXB
003C14H	003D14H	003E14H	003F14H	Acceptance mask register 0	AMR0	R/W	XXXXXXXXB
003C15H	003D15H	003E15H	003F15H				XXXXXXXXB
003C16H	003D16H	003E16H	003F16H				XXXXX---B
003C17H	003D17H	003E17H	003F17H				XXXXXXXXB
003C18H	003D18H	003E18H	003F18H	Acceptance mask register 1	AMR1	R/W	XXXXXXXXB
003C19H	003D19H	003E19H	003F19H				XXXXXXXXB
003C1AH	003D1AH	003E1AH	003F1AH				XXXXX---B
003C1BH	003D1BH	003E1BH	003F1BH				XXXXXXXXB

List of Message Buffers (ID Registers)

Address				Register	Abbre-viation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003A00H to 003A1FH	003B00H to 003B1FH	003700H to 00371FH	003800H to 00381FH	General-purpose RAM	—	R/W	XXXXXXXXB to XXXXXXXXB
003A20H	003B20H	003720H	003820H	ID register 0	IDR0	R/W	XXXXXXXXB XXXXXXXXB
003A21H	003B21H	003721H	003821H				
003A22H	003B22H	003722H	003822H				XXXXX---B XXXXXXXXB
003A23H	003B23H	003723H	003823H				
003A24H	003B24H	003724H	003824H	ID register 1	IDR1	R/W	XXXXXXXXB XXXXXXXXB
003A25H	003B25H	003725H	003825H				
003A26H	003B26H	003726H	003826H				XXXXX---B XXXXXXXXB
003A27H	003B27H	003727H	003827H				
003A28H	003B28H	003728H	003828H	ID register 2	IDR2	R/W	XXXXXXXXB XXXXXXXXB
003A29H	003B29H	003729H	003829H				
003A2AH	003B2AH	00372AH	00382AH				XXXXX---B XXXXXXXXB
003A2BH	003B2BH	00372BH	00382BH				
003A2CH	003B2CH	00372CH	00382CH	ID register 3	IDR3	R/W	XXXXXXXXB XXXXXXXXB
003A2DH	003B2DH	00372DH	00382DH				
003A2EH	003B2EH	00372EH	00382EH				XXXXX---B XXXXXXXXB
003A2FH	003B2FH	00372FH	00382FH				
003A30H	003B30H	003730H	003830H	ID register 4	IDR4	R/W	XXXXXXXXB XXXXXXXXB
003A31H	003B31H	003731H	003831H				
003A32H	003B32H	003732H	003832H				XXXXX---B XXXXXXXXB
003A33H	003B33H	003733H	003833H				
003A34H	003B34H	003734H	003834H	ID register 5	IDR5	R/W	XXXXXXXXB XXXXXXXXB
003A35H	003B35H	003735H	003835H				
003A36H	003B36H	003736H	003836H				XXXXX---B XXXXXXXXB
003A37H	003B37H	003737H	003837H				
003A38H	003B38H	003738H	003838H	ID register 6	IDR6	R/W	XXXXXXXXB XXXXXXXXB
003A39H	003B39H	003739H	003839H				
003A3AH	003B3AH	00373AH	00383AH				XXXXX---B XXXXXXXXB
003A3BH	003B3BH	00373BH	00383BH				
003A3CH	003B3CH	00373CH	00383CH	ID register 7	IDR7	R/W	XXXXXXXXB XXXXXXXXB
003A3DH	003B3DH	00373DH	00383DH				
003A3EH	003B3EH	00373EH	00383EH				XXXXX---B XXXXXXXXB
003A3FH	003B3FH	00373FH	00383FH				

(Continued)

List of Message Buffers (Data register)

Address				Register	Abbre-viation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003A80H to 003A87H	003B80H to 003B87H	003780H to 003787H	003880H to 003887H	Data register 0 (8 bytes)	DTR0	R/W	XXXXXXXXB to XXXXXXXXB
003A88H to 003A8FH	003B88H to 003B8FH	003788H to 00378FH	003888H to 00388FH	Data register 1 (8 bytes)	DTR1	R/W	XXXXXXXXB to XXXXXXXXB
003A90H to 003A97H	003B90H to 003B97H	003790H to 003797H	003890H to 003897H	Data register 2 (8 bytes)	DTR2	R/W	XXXXXXXXB to XXXXXXXXB
003A98H to 003A9FH	003B98H to 003B9FH	003798H to 00379FH	003898H to 00389FH	Data register 3 (8 bytes)	DTR3	R/W	XXXXXXXXB to XXXXXXXXB
003AA0H to 003AA7H	003BA0H to 003BA7H	0037A0H to 0037A7H	0038A0H to 0038A7H	Data register 4 (8 bytes)	DTR4	R/W	XXXXXXXXB to XXXXXXXXB
003AA8H to 003AAFH	003BA8H to 003BAFH	0037A8H to 0037AFH	0038A8H to 0038AFH	Data register 5 (8 bytes)	DTR5	R/W	XXXXXXXXB to XXXXXXXXB
003AB0H to 003AB7H	003BB0H to 003BB7H	0037B0H to 0037B7H	0038B0H to 0038B7H	Data register 6 (8 bytes)	DTR6	R/W	XXXXXXXXB to XXXXXXXXB
003AB8H to 003ABFH	003BB8H to 003BBFH	0037B8H to 0037BFH	0038B8H to 0038BFH	Data register 7 (8 bytes)	DTR7	R/W	XXXXXXXXB to XXXXXXXXB
003AC0H to 003AC7H	003BC0H to 003BC7H	0037C0H to 0037C7H	0038C0H to 0038C7H	Data register 8 (8 bytes)	DTR8	R/W	XXXXXXXXB to XXXXXXXXB
003AC8H to 003ACFH	003BC8H to 003BCFH	0037C8H to 0037CFH	0038C8H to 0038CFH	Data register 9 (8 bytes)	DTR9	R/W	XXXXXXXXB to XXXXXXXXB
003AD0H to 003AD7H	003BD0H to 003BD7H	0037D0H to 0037D7H	0038D0H to 0038D7H	Data register 10 (8 bytes)	DTR10	R/W	XXXXXXXXB to XXXXXXXXB
003AD8H to 003ADFH	003BD8H to 003BDFH	0037D8H to 0037DFH	0038D8H to 0038DFH	Data register 11 (8 bytes)	DTR11	R/W	XXXXXXXXB to XXXXXXXXB
003AE0H to 003AE7H	003BE0H to 003BE7H	0037E0H to 0037E7H	0038E0H to 0038E7H	Data register 12 (8 bytes)	DTR12	R/W	XXXXXXXXB to XXXXXXXXB
003AE8H to 003AEFH	003BE8H to 003BEFH	0037E8H to 0037EFH	0038E8H to 0038EFH	Data register 13 (8 bytes)	DTR13	R/W	XXXXXXXXB to XXXXXXXXB
003AF0H to 003AF7H	003BF0H to 003BF7H	0037F0H to 0037F7H	0038F0H to 0038F7H	Data register 14 (8 bytes)	DTR14	R/W	XXXXXXXXB to XXXXXXXXB
003AF8H to 003AFFH	003BF8H to 003BFFH	0037F8H to 0037FFH	0038F8H to 0038FFH	Data register 15 (8 bytes)	DTR15	R/W	XXXXXXXXB to XXXXXXXXB

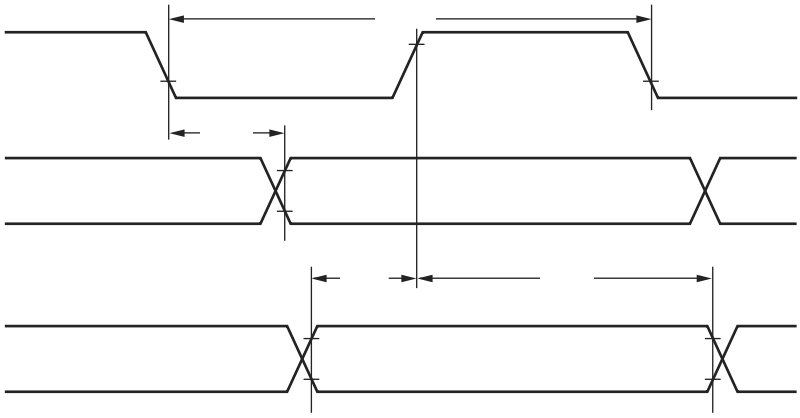
4. AC Characteristics

(1) Clock timing

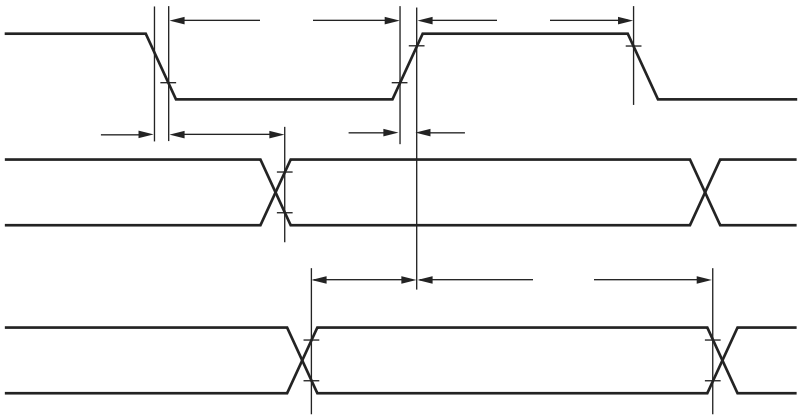
(V_{CC} = 5.0 V ±10%, V_{SS} = DV_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Clock frequency	F_C	X0, X1	—	3	—	16	MHz	1/2 (PLL stopped) When using the oscillator circuit
				3	—	32	MHz	1/2 (PLL stopped) When using an external clock
				4	—	32	MHz	PLL multiplied by 1
				3	—	16	MHz	PLL multiplied by 2
				3	—	10.7	MHz	PLL multiplied by 3
				3	—	8	MHz	PLL multiplied by 4
				3	—	5.33	MHz	PLL multiplied by 6
				3	—	4	MHz	PLL multiplied by 8
	F_{LC}	X0A, X1A		—	32.768	—	kHz	
Clock cycle time	t_{CYL}	X0, X1		62.5	—	333	ns	When using an oscillator
				31.25	—	333	ns	External clock input
	t_{LCYL}	X0A, X1A		—	30.5	—	µs	
Input clock pulse width	P_{WH}, P_{WL}	X0		5	—	—	ns	Use duty ratio of 50% ± 3% as a guideline
	P_{WLH}, P_{WLL}	X0A		—	15.2	—	µs	
Input clock rise and fall time	tcr, tcf	X0		—	—	5	ns	When using an external clock signal
Internal operating clock frequency	F_{CP}	—		1.5	—	32	MHz	Using main clock (PLL clock)
	F_{LCP}	—		—	8.192	—	kHz	Using sub clock
Internal operating clock cycle time	t_{CP}	—		31.25	—	666	ns	Using main clock (PLL clock)
	t_{LCP}	—		—	122.1	—	µs	Using sub clock

- Internal shift clock mode



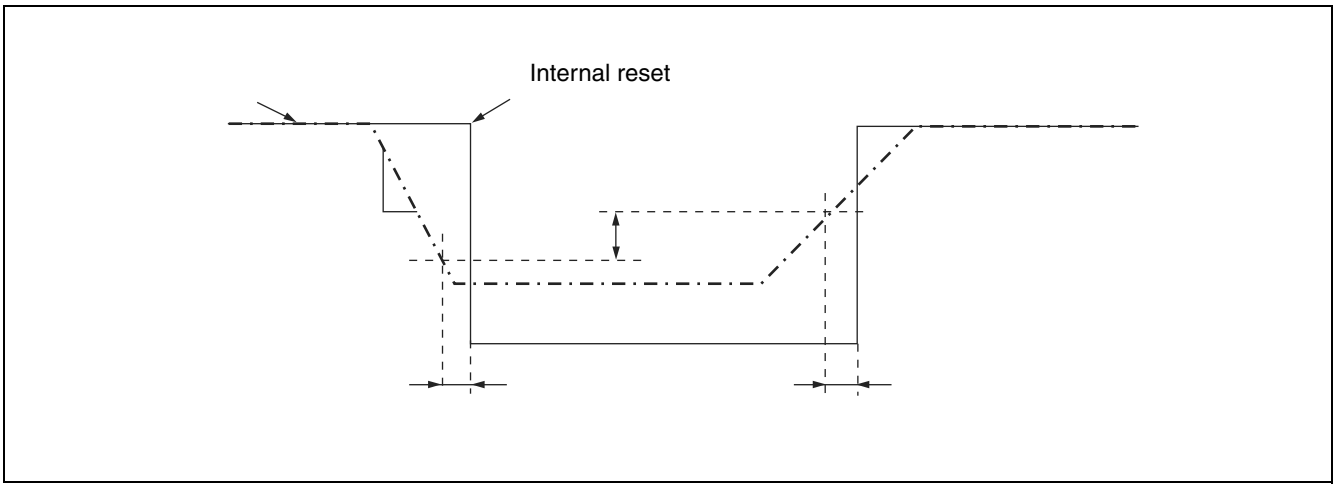
- External shift clock mode



(7) Low voltage detection

(V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

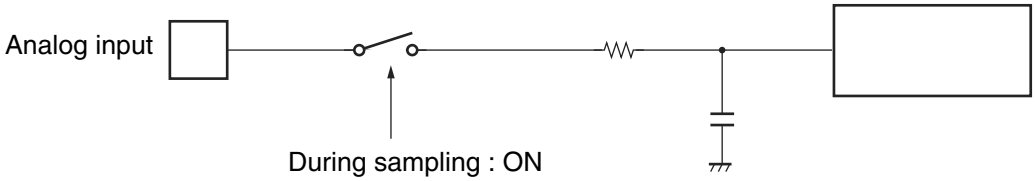
Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Detection voltage	V_{DL}	VCC	—	4.0	4.2	4.4	V	Flash memory product, during voltage drop
				3.7	4.0	4.3	V	Evaluation product, during voltage drop
Hysteresis width	V_{HYS}	VCC	—	190	—	—	mV	Flash memory product, during voltage rise
				0.1	—	—	V	Evaluation product, during voltage rise
Power supply voltage change rate	dV/dt	VCC	—	– 0.1	—	+ 0.1	V/µs	Flash memory product, dV/dt at low voltage reset
				–0.004	—	+ 0.004	V/µs	Flash memory product, dV/dt at standard value of low voltage detection/release voltage
				– 0.1	—	+ 0.02	V/µs	Evaluation product
Detection delay time	td	—	—	—	—	3.2	µs	Flash memory product, when dV/dt ≤ 0.004 V/µs
				—	—	35	µs	Evaluation product



• **Notes on the external impedance and sampling time of analog inputs**

A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. If the sampling time is still not sufficient, connect a capacitor of about 0.1 μF to the analog input pin.

• Analog input equivalent circuit



MB90F922NC/F922NCS/ F923NC/F923NCS/F924NC/F924NCS
MB90922NCS

	R	C
4.5 V ≤ AVcc ≤ 5.5 V :	2.6 kΩ (Max)	8.5 pF (Max)
4.0 V ≤ AVcc ≤ 4.5 V :	12.1 kΩ (Max)	8.5 pF (Max)

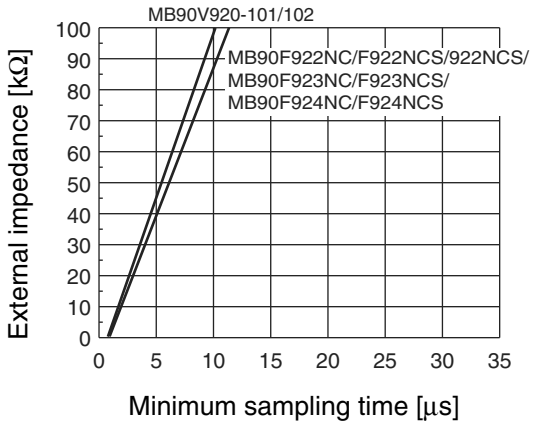
MB90V920-101/102

4.5 V ≤ AVcc ≤ 5.5 V :	2.0 kΩ (Max)	14.4 pF (Max)
4.0 V ≤ AVcc ≤ 4.5 V :	8.2 kΩ (Max)	14.4 pF (Max)

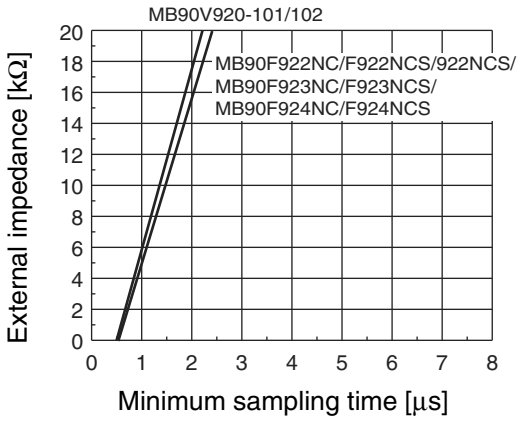
Note : The values are reference values.

- The relationship between the external impedance and minimum sampling time
- At 4.5 V ≤ AVcc ≤ 5.5 V

(External impedance = 0 kΩ to 100 kΩ)

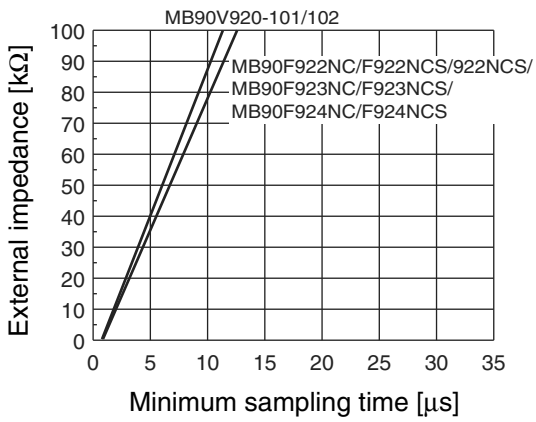


(External impedance = 0 kΩ to 20 kΩ)

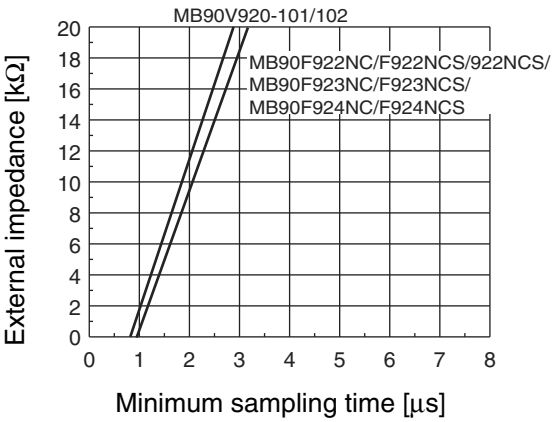


- At 4.0 V ≤ AVcc ≤ 4.5 V

(External impedance = 0 kΩ to 100 kΩ)



(External impedance = 0 kΩ to 20 kΩ)



- About errors
  As |AVRH - AVSS| becomes smaller, the relative errors grow larger.

6. Flash Memory Program/Erase Characteristics

Parameter	Conditions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time	T_A = + 25 °C V_{CC} = 5.0 V	—	0.9	3.6	s	Excludes pre-programming before erase
Word (16-bit width) programming time		—	23	370	µs	Excludes system-level overhead
Chip programming time	T_A = + 25 °C, V_{CC} = 5.0 V	—	3.4	55	s	
Erase/program cycle	—	10000	—	—	cycle	
Flash memory data retention time	Average T_A = + 85 °C	20	—	—	year	*

* : This value is calculated from the results of evaluating the reliability of the technology (using Arrhenius equation to translate high temperature measurements into normalized value at + 85 °C) .

■ ORDERING INFORMATION

Part number	Package	Remarks
MB90F922NCPMC MB90F922NCSPMC MB90922NCSPMC MB90F923NCPMC MB90F923NCSPMC MB90F924NCPMC MB90F924NCSPMC	120-pin plastic LQFP (FPT-120P-M21)	
MB90V920-101CR MB90V920-102CR	299-pin ceramic PGA (PGA-299C-A01)	For evaluation